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A circular stamp with the text "O.I.P.E. JC59" at the top and "OCT 31 2003" in the center. The bottom arc of the stamp contains the words "PATENT & TRADEMARK OFFICE".

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				<p>PATENT & TRADEMARK</p>	
				<p>Application Number</p>	09/497,992
				<p>Filing Date</p>	Feb 04, 2000
				<p>First Named Inventor</p>	Maller
				<p>Group Art Unit</p>	2141
				<p>Examiner Name</p>	BAUGH, APRIL L
Sheet	1	of	1	<p>Attorney Docket Number</p>	
				MS1-353US	

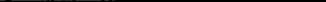
U.S. PATENT DOCUMENTS

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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Unique citation designation number. ² See attached Kinds of U.S. Patent Documents. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

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